December 2014

FCH110N65F — N-Channel SuperFET[®] II FRFET[®] MOSFET



FCH110N65F N-Channel SuperFET[®] II FRFET[®] MOSFET 650 V, 35 A, 110 m Ω

Features

- 700 V @ T_J = 150°C
- Typ. R_{DS(on)} = 96 mΩ (Typ.)
- Ultra Low Gate Charge (Typ. Q_g = 98 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 464 pF)
- 100% Avalanche Tested
- RoHS Compliant

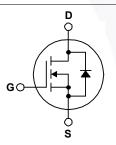
Applications

- LCD / LED / PDP TV
 Telecom / Server Power Supplies
- Solar Inverter
 AC DC Power Supply

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications. SuperFET II FRFET[®] MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter			FCH110N65F_F155	Unit
V _{DSS}	Drain to Source Voltage		650	V	
V _{GSS}	Gate to Source Voltage	- DC	- DC		V
		- AC	(f > 1 Hz)	±30	v
ID	Drain Current	- Continuous (T _C = 25 ^o C)		35	А
		- Continuous (T _C = 100 ^o C)		24	A
I _{DM}	Drain Current	- Pulsed	(Note 1)	105	Α
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		809	mJ	
I _{AR}	Avalanche Current (Note 1)		8	Α	
E _{AR}	Repetitive Avalanche Energy (Note 1)		3.57	mJ	
dv/dt	MOSFET dv/dt			100	Mag
	Peak Diode Recovery dv/dt (Note 3)			50	V/ns
P _D	Rower Dissinction	(T _C = 25°C)		357	W
	Power Dissipation	- Derate Above 25°C		2.86	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C	

Thermal Characteristics

Symbol	Parameter	FCH110N65F_F155	Unit	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.35	°C/W	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	40	°C/W	

FCH110N65	nber	Top Mark	Package	Packing Method	Reel Size	Тар	e Width	Qua	ntity
			TO-247G03	Tube	N/A		N/A	30 units	
Electrical	Chara	acteristics T _c =	: 25 ⁰ C unless (therwise noted					
Symbol	Undre	Parameter	20 0 0 0 0 0 0	Test Conditi	ions	Min.	Тур.	Max.	Unit
Off Charact	hariation			Test oonun	0113		Typ.	Max.	onn
UII Charact) 		$V_{00} = 0 V_{10} = 10 mA$	T. = 25°C	650	-		
BV _{DSS}	Drain to	rain to Source Breakdown Voltage		$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 10 \text{ mA}, \text{ T}_{J} = 25^{\circ}\text{C}$ $V_{GS} = 0 \text{ V}, \text{ I}_{D} = 10 \text{ mA}, \text{ T}_{J} = 150^{\circ}\text{C}$		700	-	-	V
ΔΒV _{DSS} / ΔΤ.	Breakdown Voltage Temperature		ure	$V_{GS} = 0$ V, $I_D = 10$ mA, $T_J = 150$ C $I_D = 10$ mA, Referenced to 25°C		-	0.72	-	V/ºC
, , , ,				V _{DS} = 650 V, V _{GS} = 0	V	-	-	10	
DSS	Zero Gate Voltage Drain Current		ent	V _{DS} = 520 V, T _C = 125	5°C	-	110	u/	
I _{GSS}	Gate to E	Gate to Body Leakage Current		$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	V	-	-	±100	nA
On Charact	eristics								
V _{GS(th)}	Gate Th	reshold Voltage		V _{GS} = V _{DS} , I _D = 3.5 m	A	3	-	5	V
R _{DS(on)}		ain to Source On Res	sistance	V _{GS} = 10 V, I _D = 17.5 /		-	96	110	mΩ
9 _{FS}	Forward	Transconductance		V _{DS} = 20 V, I _D = 17.5 /	A	-	30	-	S
Dynamic Cl	haracte	ristics							
C _{iss}		pacitance					3680	4895	pF
C _{oss}	-	Capacitance		V _{DS} = 100 V, V _{GS} = 0	V,		110	145	pF
C _{rss}		Transfer Capacitance	e.	f = 1 MHz	-	-	0.65	-	pF
C _{oss}		Capacitance		V _{DS} = 380 V, V _{GS} = 0 V, f = 1 MHz		-	65	-	pF
C _{oss(eff.)}	-	e Output Capacitance		$V_{\rm DS} = 0 \text{ V to } 400 \text{ V}, V_{\rm GS} = 0 \text{ V}$		-	464	_	pF
Q _{g(tot)}		te Charge at 10V		V _{DS} = 380 V, I _D = 17.5 A,		-	98	145	nC
Q _{gs}		Source Gate Charge		$V_{GS} = 10 V$	-	20	-	nC	
Q _{gd}		Drain "Miller" Charge			(Note 4)	-	43	-	nC
ESR	Equivale	uivalent Series Resistance		f = 1 MHz		-	0.7	-	Ω
Switching (Charact	eristics							
-		Delay Time					31	72	ns
t _{d(on)} t _r		Rise Time		V_{DD} = 380 V, I _D = 17.5 A, V _{GS} = 10 V, R _g = 4.7 Ω			21	52	ns
t _{d(off)}		Delay Time					89	188	ns
- <u>d(011)</u> t _f		Fall Time			(Note 4)	7 -	5.7	21	ns
	oo Diod	e Characteristic	•						1
				Forward Current				25	•
	IVIAXIIIIUII	n Pulsed Drain to Sou		le Forward Current		-	-	35 105	A
I _S	Movimum		I'CE DIQUE FOI			-	-	1.2	
I _S I _{SM}				$V_{ab} = 0 V _{ab} = 175 /$	Δ	_			
Drain-Sourd I _S I _{SM} V _{SD} t _{rr}	Drain to S	Source Diode Forwar Recovery Time		$V_{GS} = 0 V, I_{SD} = 17.5 V$ $V_{GS} = 0 V, I_{SD} = 17.5 V$		-	- 133	1.2	V ns

2

8

7

1.5

V_{DS} = 520V

80

1.8

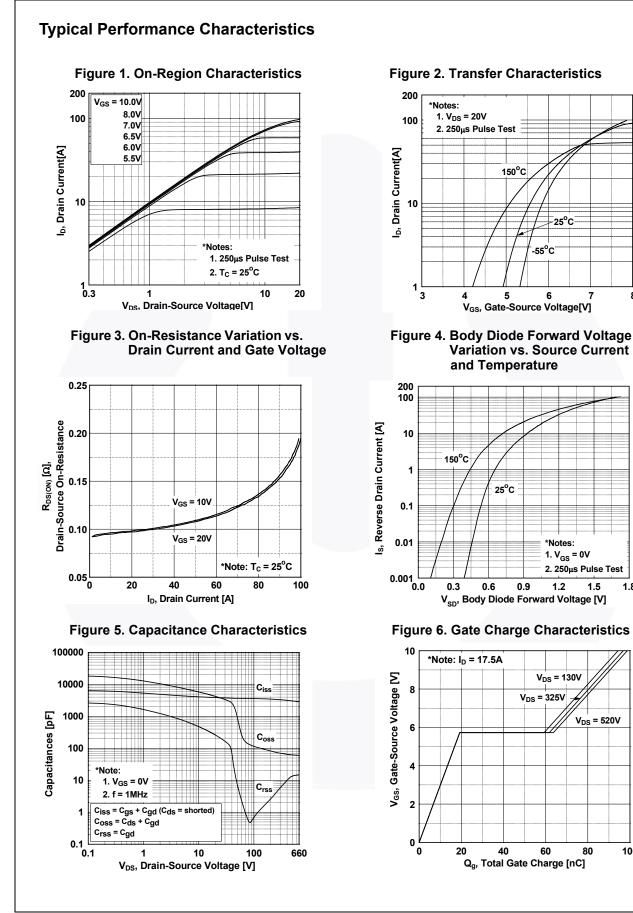


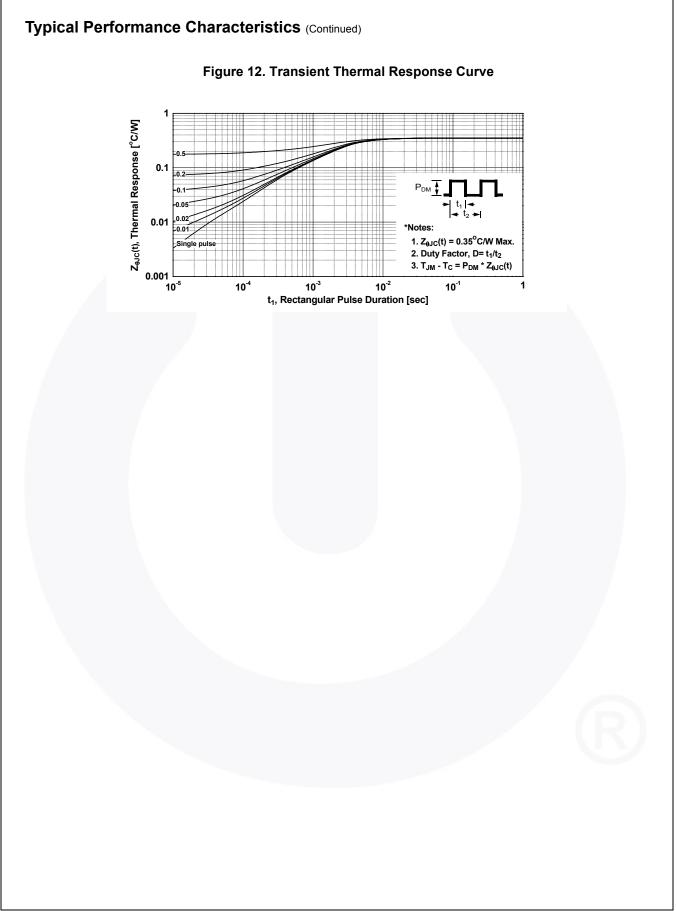
Figure 2. Transfer Characteristics

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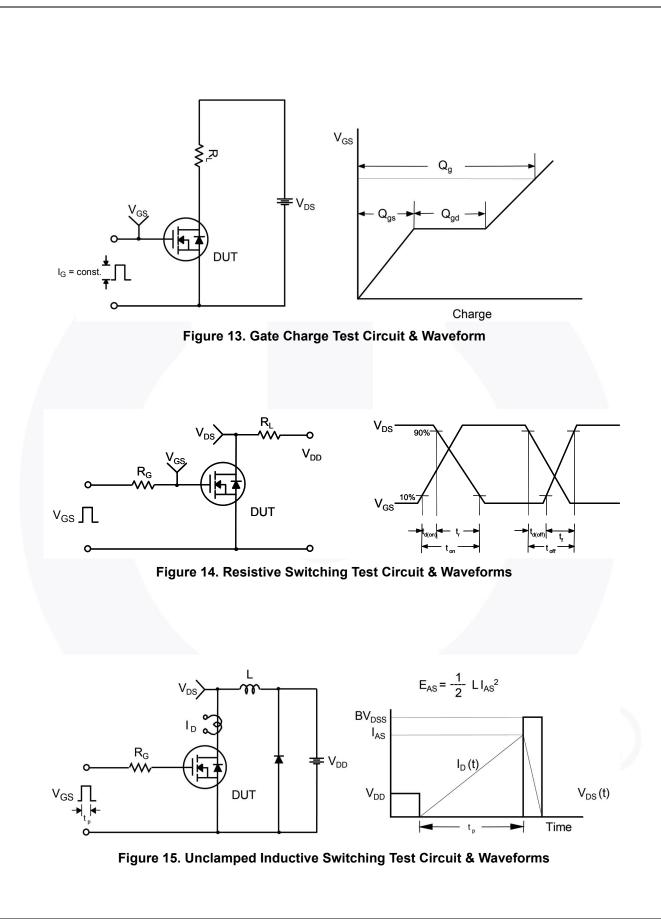
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100

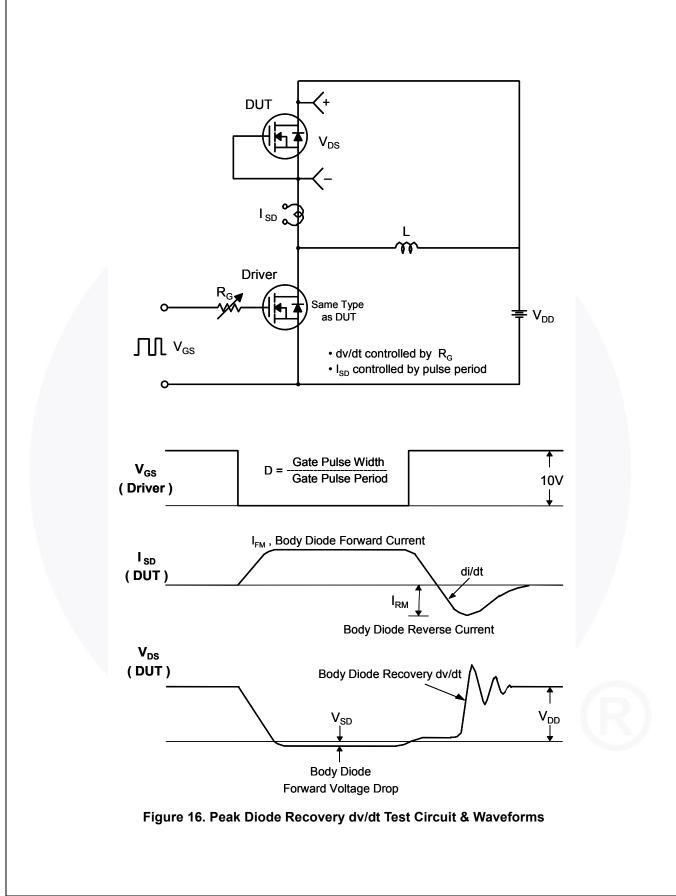
Typical Performance Characteristics (Continued) Figure 7. Breakdown Voltage Variation Figure 8. On-Resistance Variation vs. Temperature vs. Temperature 2.5 1.15 *Notes: *Notes: Drain-Source Breakdown Voltage 1. V_{GS} = 10V 1. V_{GS} = 0V Drain-Source On-Resistance 0. 2.1 0. 2.1 2. I_D = 17.5A 2. I_D = 10mA 1.10 R_{DS(on)}, [Normalized] BV_{DSS}, [Normalized] 1.05 1.00 0.95 0.5 └─ -100 0.90 L -100 -50 0 50 100 150 200 0 50 100 150 200 -50 T_J, Junction Temperature [°C] T_J, Junction Temperature [^oC] Figure 9. Maximum Safe Operating Area Figure 10. Maximum Drain Current vs. Case Temperature 300 40 100 10µs 100µs l_b, Drain Current [A] 30 I_D, Drain Current [A] 10 1ms 20 DC 1 **Operation in This Area** is Limited by R DS(on) Notes: 10 1. T_C = 25°C 0.1 2. T_J = 150^oC 3. Single Pulse 0.01 └─ 0.1 0 ∟ 25 10 100 1000 50 75 100 125 150 1 T_c, Case Temperature [°C] V_{DS}, Drain-Source Voltage [V] Figure 11. Eoss vs. Drain to Source Voltage 20 16 Е_{oss}, [µJ] 12 8 4 0 132 264 396 528 V_{DS}, Drain to Source Voltage [V] 660

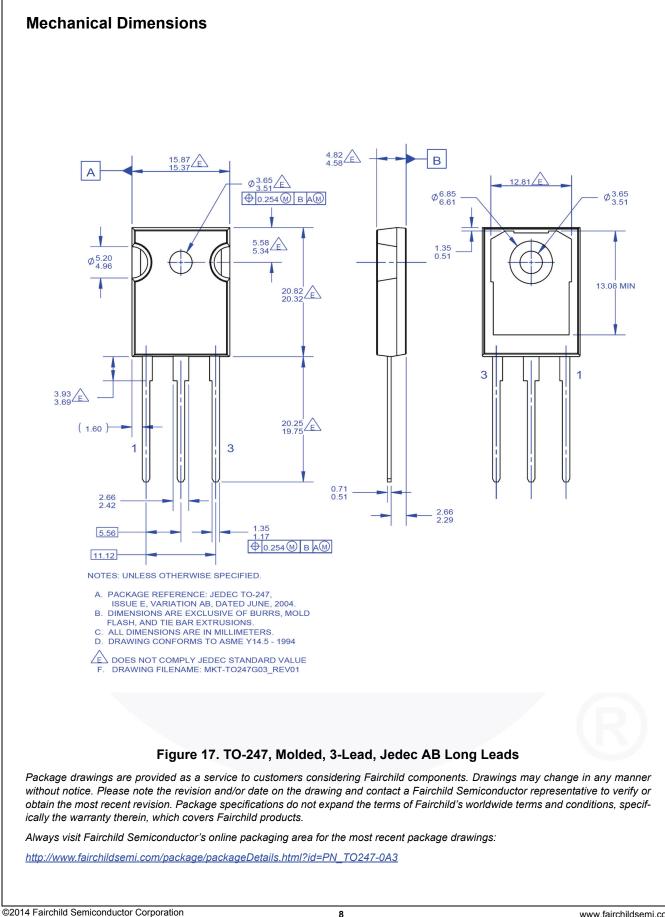


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